

<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> <i>( Not for submission under 37 CFR 1.99)</i>	Application Number	10807873
	Filing Date	2005-09-09
	First Named Inventor	Stasiak et al
	Art Unit	
	Examiner Name	
	Attorney Docket Number	200309781-1

**U.S.PATENTS**

Examiner Initial*	Cite No	Patent Number	Kind Code <sup>1</sup>	Issue Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
	1	5948621	A	1999-09-07	Turner et al	
	2	5776748	A	1998-07-07	Singhvi	

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**U.S.PATENT APPLICATION PUBLICATIONS**

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	1	20030054342	A1	2003-03-20	Star et al	
	2	20020119251	A1	2002-08-29	Chen et al	
	3	20030032046	A1	2003-02-13	Duffy et al	
	4	20050118338	A1	2005-06-02	Steve et al	

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**FOREIGN PATENT DOCUMENTS**

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10807873 GAU: 1792

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	1	1 484 644	EP	A	2004-12-08	Hewlett Packard		<input type="checkbox"/>
	2	2004/092836	WO	A	2004-10-28	Drain		<input type="checkbox"/>

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	1	Chou, S. et al "Imprint Lithography with Sub-10 nm Feature Size and High Throughput", Microelectronic Engineering, V. 35(1), Feb 1997. pp 237-240	<input type="checkbox"/>
	2	Pfeiffer K et al, "Polymer stamps for nanoimprinting", Microelectronic Engineering, V 61-62, July 2002, pp 393-398	<input type="checkbox"/>
	3	Schift H et al, "Chemical non-patterning using hot embossing lithography", Microelectronic Engineering, V. 61-62, July 2002, pp 423-428	<input type="checkbox"/>
	4	Elsner C et al, "3D-microstructure replication processes using UV-curable acrylates", Microelectronic Engineering, V 65 (1-2, pp 163-170	<input type="checkbox"/>

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